



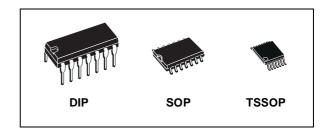
# 8-INPUT NAND GATE

- HIGH SPEED:
  - $t_{PD}$  = 13ns (TYP.) at  $V_{CC}$  = 6V
- LOW POWER DISSIPATION:  $I_{CC} = 1\mu A(MAX.)$  at  $T_A=25$ °C
- HIGH NOISE IMMUNITY: V<sub>NIH</sub> = V<sub>NIL</sub> = 28 % V<sub>CC</sub> (MIN.)
- SYMMETRICAL OUTPUT IMPEDANCE: |I<sub>OH</sub>| = I<sub>OL</sub> = 4mA (MIN)
- BALANCED PROPAGATION DELAYS: t<sub>PLH</sub> ≅ t<sub>PHL</sub>
- WIDE OPERATING VOLTAGE RANGE: V<sub>CC</sub> (OPR) = 2V to 6V
- PIN AND FUNCTION COMPATIBLE WITH 74 SERIES 30



The M74HC30 is an high speed CMOS 8-INPUT NAND GATE fabricated with silicon gate C<sup>2</sup>MOS technology.

The internal circuit is composed of 5 stages including buffer output, which enables high noise immunity and stable output.

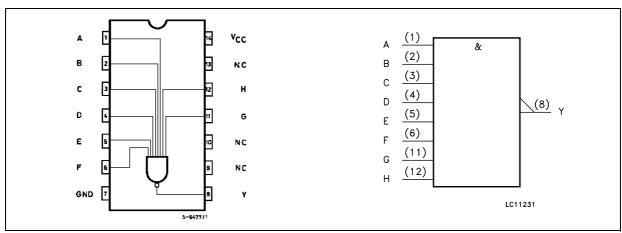


#### **ORDER CODES**

PACKAGE	TUBE	T & R
DIP	M74HC30B1R	
SOP	M74HC30M1R	M74HC30RM13TR
TSSOP		M74HC30TTR

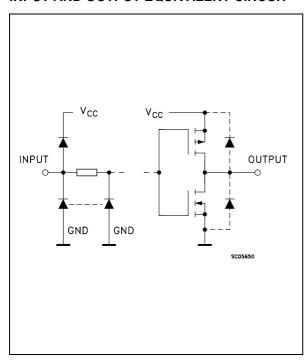
All inputs are equipped with protection circuits against static discharge and transient excess voltage.

#### PIN CONNECTION AND IEC LOGIC SYMBOLS



July 2001 1/8

### INPUT AND OUTPUT EQUIVALENT CIRCUIT



### **PIN DESCRIPTION**

PIN No	SYMBOL	NAME AND FUNCTION
1, 2, 3 ,4, 5, 6, 11, 12	A, B, C, D, E, F, G, H,	Data Inputs
9, 10, 13	NC	Not connected
8	Y	Data Output
7	GND	Ground (0V)
14	V <sub>CC</sub>	Positive Supply Voltage

#### **TRUTH TABLE**

Α	В	С	D	E	F	G	Н	Υ
L	Х	Х	Х	Х	Χ	Х	Х	Н
Х	L	Χ	Χ	Χ	Χ	Х	Х	Н
Х	Χ	L	Χ	Χ	Χ	Х	Х	Н
Х	Χ	Χ	L	Χ	Χ	Χ	Χ	Н
Χ	Χ	Χ	Χ	L	Х	Χ	Χ	Н
Χ	Χ	Χ	Χ	Χ	L	Χ	Χ	Н
Х	Χ	Χ	Χ	Χ	Χ	L	Χ	Н
Х	Χ	Χ	Χ	Χ	Χ	Χ	L	Н
Н	Н	Н	Н	Н	Н	Н	Н	L

### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	-0.5 to +7	V
V <sub>I</sub>	DC Input Voltage	-0.5 to V <sub>CC</sub> + 0.5	V
V <sub>O</sub>	DC Output Voltage	-0.5 to V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	DC Input Diode Current	± 20	mA
I <sub>OK</sub>	DC Output Diode Current	± 20	mA
Io	DC Output Current	± 25	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current	± 50	mA
P <sub>D</sub>	Power Dissipation	500(*)	mW
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C
T <sub>L</sub>	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied

(\*) 500mW at 65 °C; derate to 300mW by 10mW/°C from 65°C to 85°C

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter		Value	Unit
V <sub>CC</sub>	Supply Voltage		2 to 6	V
V <sub>I</sub>	Input Voltage		0 to V <sub>CC</sub>	V
Vo	Output Voltage		0 to V <sub>CC</sub>	V
T <sub>op</sub>	Operating Temperature		-55 to 125	°C
	Input Rise and Fall Time	V <sub>CC</sub> = 2.0V	0 to 1000	ns
$t_r$ , $t_f$	7	V <sub>CC</sub> = 4.5V	0 to 500	ns
	Ţ	$V_{CC} = 6.0V$	0 to 400	ns

### **DC SPECIFICATIONS**

		٦	est Condition	Value							
Symbol	Parameter	v <sub>cc</sub>		T <sub>A</sub> = 25°C			-40 to 85°C		-55 to 125°C		Unit
		(V)		Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
V <sub>IH</sub>	High Level Input	2.0		1.5			1.5		1.5		
	Voltage	4.5		3.15			3.15		3.15		V
		6.0		4.2			4.2		4.2		
$V_{IL}$	Low Level Input	2.0				0.5		0.5		0.5	
	Voltage	4.5				1.35		1.35		1.35	V
		6.0				1.8		1.8		1.8	
$V_{OH}$	V <sub>OH</sub> High Level Output Voltage	2.0	I <sub>O</sub> =-20 μA	1.9	2.0		1.9		1.9		
		4.5	I <sub>O</sub> =-20 μA	4.4	4.5		4.4		4.4		
		6.0	I <sub>O</sub> =-20 μA	5.9	6.0		5.9		5.9		V
		4.5	I <sub>O</sub> =-4.0 mA	4.18	4.31		4.13		4.10		
		6.0	I <sub>O</sub> =-5.2 mA	5.68	5.8		5.63		5.60		
V <sub>OL</sub>	Low Level Output	2.0	I <sub>O</sub> =20 μA		0.0	0.1		0.1		0.1	
	Voltage	4.5	I <sub>O</sub> =20 μA		0.0	0.1		0.1		0.1	
		6.0	I <sub>O</sub> =20 μA		0.0	0.1		0.1		0.1	V
		4.5	I <sub>O</sub> =4.0 mA		0.17	0.26		0.33		0.40	
		6.0	I <sub>O</sub> =5.2 mA		0.18	0.26		0.33		0.40	
I <sub>I</sub>	Input Leakage Current	6.0	$V_I = V_{CC}$ or GND			± 0.1		± 1		± 1	μΑ
I <sub>CC</sub>	Quiescent Supply Current	6.0	V <sub>I</sub> = V <sub>CC</sub> or GND			1		10		20	μΑ

# AC ELECTRICAL CHARACTERISTICS ( $C_L = 50 \text{ pF}$ , Input $t_r = t_f = 6 \text{ns}$ )

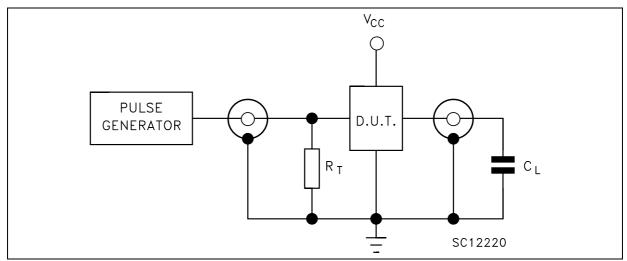
		Test Condition		Value							
Symbol	Parameter	V <sub>CC</sub>		Т	A = 25°	С	-40 to	85°C	-55 to	125°C	Unit
		V <sub>CC</sub> (V)		Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
t <sub>TLH</sub> t <sub>THL</sub>	Output Transition	2.0			30	75		95		110	
	Time	4.5			8	15		19		22	ns
		6.0			7	13		16		19	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay	2.0			45	115		145		170	
	Time	4.5			15	23		29		34	ns
		6.0			13	20		25		29	

### **CAPACITIVE CHARACTERISTICS**

			Test Condition	Value							
Symbol	Parameter	v <sub>cc</sub>		T <sub>A</sub> = 25°C			-40 to 85°C		-55 to 125°C		Unit
		(V)		Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
C <sub>IN</sub>	Input Capacitance	5.0			5	10		10		10	pF
C <sub>PD</sub>	Power Dissipation Capacitance (note 1)	5.0			20						pF

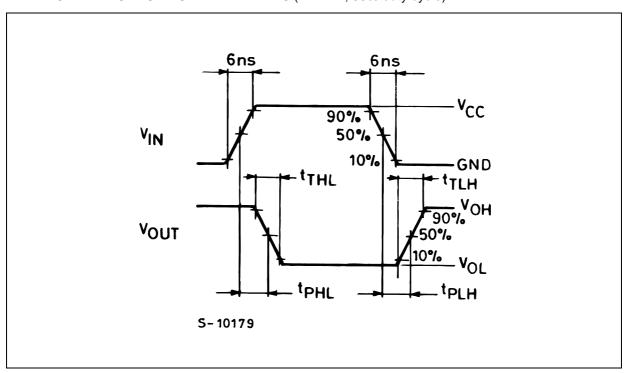
<sup>1)</sup> C<sub>PD</sub> is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation. I<sub>CC(opr)</sub> = C<sub>PD</sub> x V<sub>CC</sub> x f<sub>IN</sub> + I<sub>CC</sub> 4

### **TEST CIRCUIT**



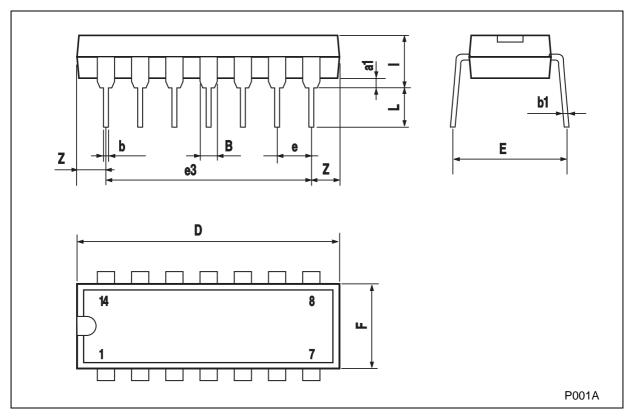
 $C_L$  = 50pF or equivalent (includes jig and probe capacitance)  $R_T$  =  $Z_{OUT}$  of pulse generator (typically 50 $\Omega$ )

### WAVEFORM: PROPAGATION DELAY TIMES (f=1MHz; 50% duty cycle)



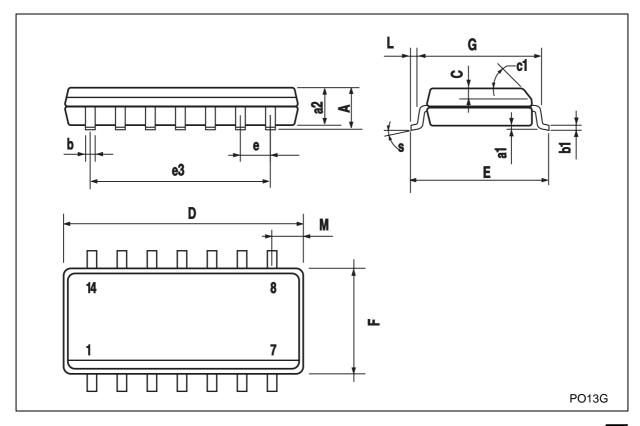
# **Plastic DIP-14 MECHANICAL DATA**

DIM		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
В	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
е		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100



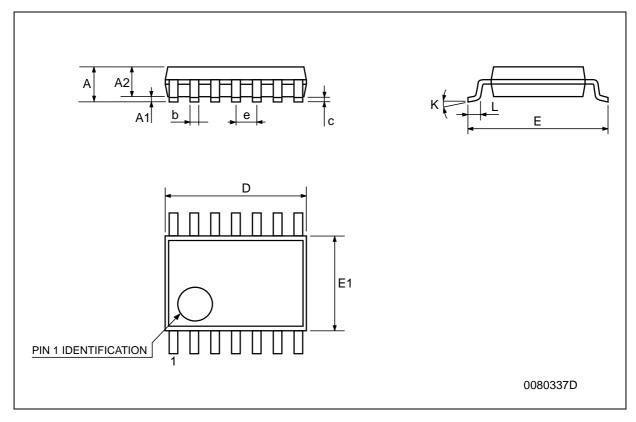
# **SO-14 MECHANICAL DATA**

DIM		mm.		inch					
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.			
Α			1.75			0.068			
a1	0.1		0.2	0.003		0.007			
a2			1.65			0.064			
b	0.35		0.46	0.013		0.018			
b1	0.19		0.25	0.007		0.010			
С		0.5			0.019				
c1			45°	(typ.)	•				
D	8.55		8.75	0.336		0.344			
E	5.8		6.2	0.228		0.244			
е		1.27			0.050				
еЗ		7.62			0.300				
F	3.8		4.0	0.149		0.157			
G	4.6		5.3	0.181		0.208			
L	0.5		1.27	0.019		0.050			
М			0.68			0.026			
S			8° (ı	max.)					



# **TSSOP14 MECHANICAL DATA**

DIM.		mm.			inch	
DIIVI.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
С	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
е		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



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